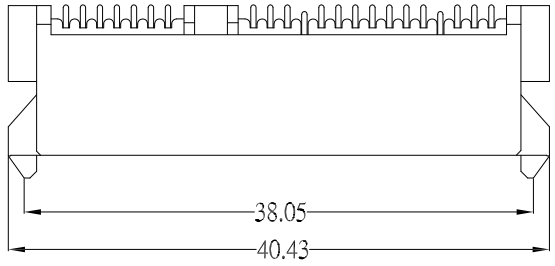
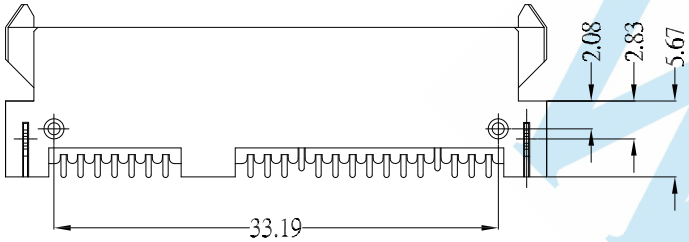
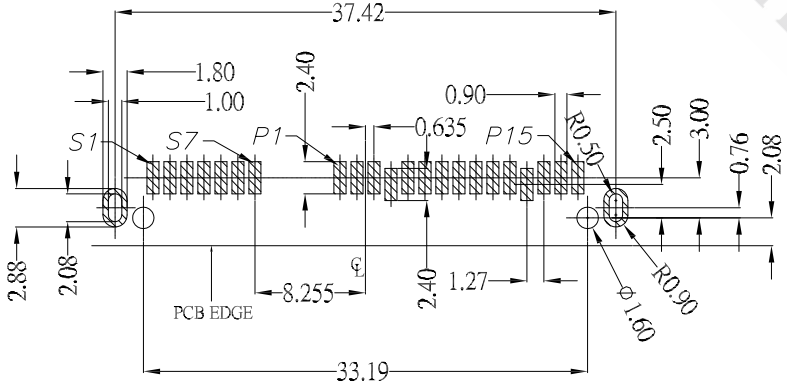
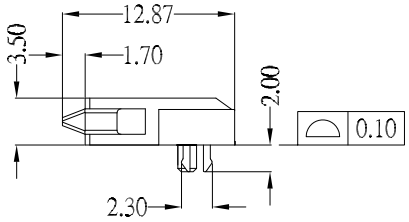
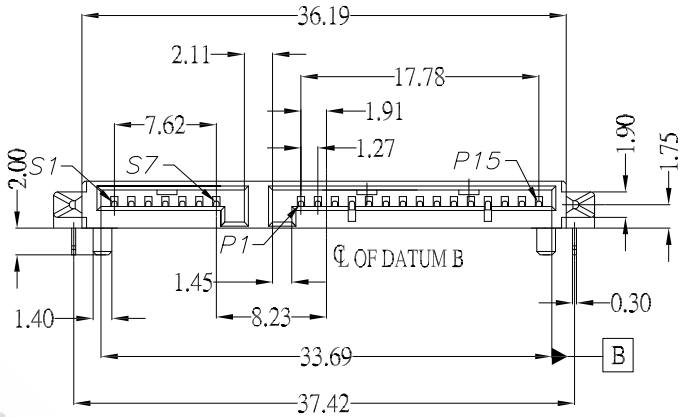






RECOMMENDED PCB LAYOUT





SPECIFICATION:

1.MATERIAL:

1.1 HOUSING: LCP , UL 94V-0 , Black.

1.2 CONTACT: PHOSPHOR BRONZE

1.3 BOARD: BRASS

2.Finish:

2.1 CONTACT: PLATED TIN IN MATING AREA ;
TIN PLATED ON SOLDER BALLS ;
NICKEL UNDER PLATED OVERALL

2.2 BOARD: TIN PLATED ON SOLDER BALLS ;
NICKEL UNDER PLATED OVERALL

WISCONN TECHNOLOGY 智宣科技

DIMENSIONS TOLERANCE METRIC									
Up to 5 ±0.2	單位(UNITS)	MM	處理(FINISH)	SEE NOTE	審校(CH'K)	Calvin	圖名(NAME) SATA 7+15P 下彈點 Female SMT H3.5mm	WISCONN Technology Co.,Ltd	
Above 5~15 ±0.3	數量(QT'Y)	N/A	繪圖(DRAW)	Johnson	核准(APP'D)	Selena	料號(PART NUMBER) WSTA-22xxLBSDR-3.5	Tel:02-2790-1979 Fax:02-2790-1569	
Above 15~30 ±0.4	材料(MT'L)	SEE NOTE	設計(DE'N)	Mike	日期(DATE)	OCT.21.2016	圖號(DRAW NUMBER) T002	比例(SCALE) 1/1	圖紙(SIZE) A4
Above 30~50 ±0.5							圖檔(FILE NAME .DWG)	頁次(SHEET) 1	版次(REV.) A
Angle ±0.3°									